

As a below-named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

	(Title of In	vention)		
the specification of wi	hich:			
(check one)				
ir Herri	is attached hereto.			
	Y was filed on March	7 1996		
	X was filed on March	7, 1990	· · · · · · · · · · · · · · · · · · ·	
	Application Serial No. 08/61	2,304		
: :	Application Bertal No			
	and was amended		·	
		(if applicable)		
including the claims	as amended hy any amendment r	the contents of the above-ic eferred to above.	, ,	,
including the claims, I acknowledge the dut	as amended by any amendment r ty to disclose to the Office all info Code of Federal Regulations, S	eferred to above. ormation known to me to be m		
including the claims, I acknowledge the dut as defined in Title 37, I hereby claim foreig application(s) for pat	as amended by any amendment r y to disclose to the Office all info	eferred to above. ormation known to me to be m ection 1.56. 5, United States Code, Section of below and have also identif	aterial to pat on 119 of an fied below an	entability y foreigr y foreigr
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I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States Application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose to the Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Moran (Reg. No. 16579), 5), John P. White (Reg. No.), Peter J. Phillips (Reg. No. Cooper & Dunham of 1185
5), John P. White (Reg. No.), Peter J. Phillips (Reg. No.
torneys, each with full power ons and amendments therein, fice connected herewith and ons of the Patent Cooperation this application to:
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under Section 1001 of Title 18 of the United States Code and that such willful false jeopardize the validity of the application or any patent issued thereon.

Full name of first joint inve		Hiroko	IWASAKI				
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